

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)				
PARAMETER	CONDITIONS	SYMBOL	VALUE	UNIT
INPUT				
Reverse voltage		V_R	3	V
Forward current		I_F	25	mA
Peak forward current	$t = 1\text{ ms}$, duty cycle 50 %	I_{FM}	50	mA
Maximum surge forward current	$t \leq 1\text{ }\mu\text{s}$, 300 pulses/s	I_{FSM}	1	A
Power dissipation		P_{diss}	45	mW
Input junction temperature		$T_{j\text{ max.}}$	125	$^{\circ}\text{C}$
OUTPUT				
Supply voltage		V_S	-0.5 to 30	V
Output voltage		V_O	-0.5 to 25	V
Emitter base voltage		V_{EBO}	5	V
Average output current		I_O	8	mA
Peak output current		I_O	16	mA
Base current		I_B	5	mA
Power dissipation		P_{diss}	100	mW
Output junction temperature		$T_{j\text{ max.}}$	125	$^{\circ}\text{C}$
COUPLER				
Storage temperature range		T_{stg}	-55 to +150	$^{\circ}\text{C}$
Ambient temperature range		T_{amb}	-40 to +100	$^{\circ}\text{C}$
Soldering temperature	max. $\leq 10\text{ s}$, dip soldering $\geq 0.5\text{ mm}$ distance from case bottom	T_{sld}	260	$^{\circ}\text{C}$

Notes

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

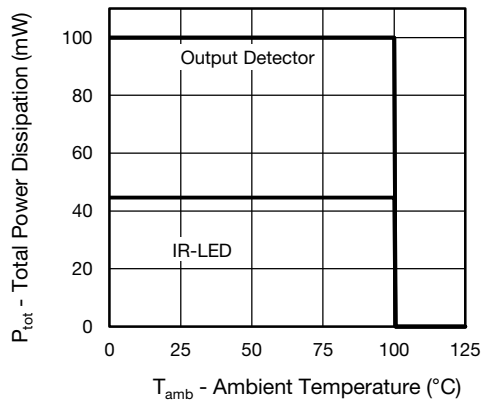


Fig. 1 - Maximum Power vs. Operating Temperature

ELECTRICAL CHARACTERISTICS ($T_{amb} = 0\text{ }^{\circ}\text{C}$ to $70\text{ }^{\circ}\text{C}$, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT							
Forward voltage	$I_F = 16\text{ mA}$		V_F		1.38	1.9	V
Breakdown voltage	$I_R = 10\text{ }\mu\text{A}$		V_{BR}	3			V
Reverse current	$V_R = 3\text{ V}$		I_R		0.5	10	μA
Input capacitance	$V_R = 0\text{ V}$, $f = 1\text{ MHz}$		C_I		36		pF
Temperature coefficient of forward voltage	$I_F = 16\text{ mA}$		$\Delta V_F/\Delta T_{amb}$		-1.9		mV/ $^{\circ}\text{C}$
OUTPUT							
Logic low supply current	$I_F = 16\text{ mA}$, $V_O = \text{open}$, $V_{CC} = 15\text{ V}$		I_{CCL}		50	200	μA
Logic high supply current	$I_F = 0\text{ A}$, $V_O = \text{open}$, $V_{CC} = 15\text{ V}$		I_{CCH}		0.02	2	μA
Output voltage, output logic low	$I_F = 16\text{ mA}$, $V_{CC} = 4.5\text{ V}$, $I_O = 0.8\text{ mA}$	VOW135	V_{OL}		0.1	0.5	V
	$I_F = 16\text{ mA}$, $V_{CC} = 4.5\text{ V}$, $I_O = 2.4\text{ mA}$	VOW136	V_{OL}		0.1	0.5	V
Output current, output logic high	$I_F = 0\text{ mA}$, $V_O = V_{CC} = 5.5\text{ V}$		I_{OH}		3	500	nA
	$I_F = 0\text{ mA}$, $V_O = V_{CC} = 15\text{ V}$		I_{OH}		0.01	1	μA
Output capacitance	$V_R = 0\text{ V}$, $f = 1\text{ MHz}$		C_O		3.70		pF
COUPLER							
Capacitance (input to output)	$f = 1\text{ MHz}$		C_{IO}		0.9		pF

Note

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

CURRENT TRANSFER RATIO ($T_{amb} = 0\text{ }^{\circ}\text{C}$ to $70\text{ }^{\circ}\text{C}$, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Current transfer ratio	$I_F = 16\text{ mA}$, $V_O = 0.4\text{ V}$, $V_{CC} = 4.5\text{ V}$, $T_{amb} = 25\text{ }^{\circ}\text{C}$	VOW135	CTR	7	18	50	%
		VOW136	CTR	19	24	50	%
	$I_F = 16\text{ mA}$, $V_O = 0.5\text{ V}$, $V_{CC} = 4.5\text{ V}$	VOW135	CTR	5	19		%
		VOW136	CTR	15	25		%

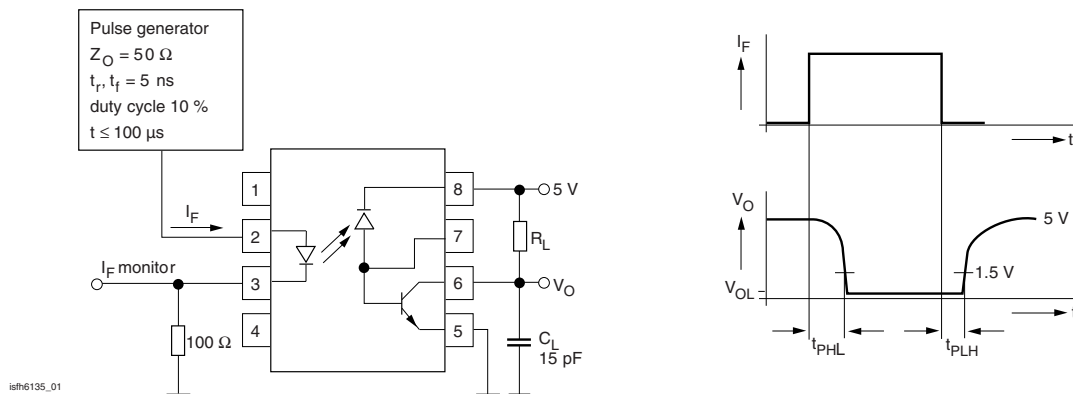


Fig. 2 - Schematics

SWITCHING CHARACTERISTICS ($T_{amb} = 0\text{ }^{\circ}\text{C}$ to $70\text{ }^{\circ}\text{C}$, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
High to low	$I_F = 16\text{ mA}$, $V_{CC} = 5\text{ V}$, $R_L = 4.1\text{ k}\Omega$	VOW135	t_{PHL}		0.2	2.0	μs
	$I_F = 16\text{ mA}$, $V_{CC} = 5\text{ V}$, $R_L = 1.9\text{ k}\Omega$	VOW136	t_{PHL}		0.2	1.0	μs
Low to high	$I_F = 16\text{ mA}$, $V_{CC} = 5\text{ V}$, $R_L = 4.1\text{ k}\Omega$	VOW135	t_{PLH}		1.3	2.0	μs
	$I_F = 16\text{ mA}$, $V_{CC} = 5\text{ V}$, $R_L = 1.9\text{ k}\Omega$	VOW136	t_{PLH}		0.6	1.0	μs

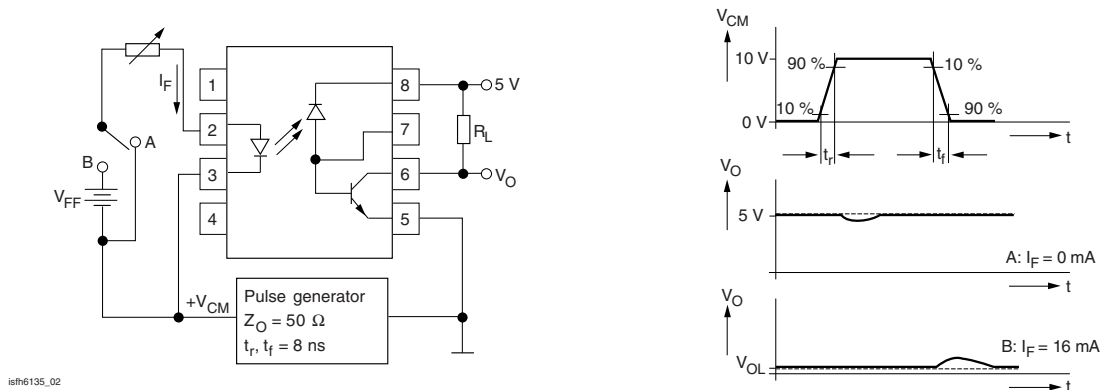


Fig. 3 - Common Mode Interference Immunity

COMMON MODE TRANSIENT IMMUNITY ($T_{amb} = 0\text{ }^{\circ}\text{C}$ to $70\text{ }^{\circ}\text{C}$, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
High	$V_{CM} = 10\text{ V}_{PP}$, $V_{CC} = 5\text{ V}$, $I_F = 0\text{ mA}$, $R_L = 4.1\text{ k}\Omega$	VOW135	CM_H	1000			$\text{V}/\mu\text{s}$
	$V_{CM} = 10\text{ V}_{PP}$, $V_{CC} = 5\text{ V}$, $I_F = 0\text{ mA}$, $R_L = 1.9\text{ k}\Omega$	VOW136	CM_H	1000			$\text{V}/\mu\text{s}$
Low	$V_{CM} = 10\text{ V}_{PP}$, $V_{CC} = 5\text{ V}$, $I_F = 16\text{ mA}$, $R_L = 4.1\text{ k}\Omega$	VOW135	CM_L	1000			$\text{V}/\mu\text{s}$
	$V_{CM} = 10\text{ V}_{PP}$, $V_{CC} = 5\text{ V}$, $I_F = 16\text{ mA}$, $R_L = 1.9\text{ k}\Omega$	VOW136	CM_L	1000			$\text{V}/\mu\text{s}$

SAFETY AND INSULATION RATINGS				
PARAMETER		SYMBOL	VALUE	UNIT
Climatic classification (according to IEC 68 part 1)			55/100/21	
Comparative tracking index		CTI	250	
Maximum rated withstanding isolation voltage	$t = 1\text{ min}$	V_{ISO}	5300	V_{RMS}
Maximum transient isolation voltage		V_{IOTM}	8000	V_{peak}
Maximum repetitive peak isolation voltage		V_{IORM}	1414	V_{peak}
Insulation resistance	$T_{amb} = 25\text{ }^{\circ}\text{C}$, $V_{DC} = 500\text{ V}$	R_{IO}	$\geq 10^{12}$	Ω
	$T_{amb} = 100\text{ }^{\circ}\text{C}$, $V_{DC} = 500\text{ V}$	R_{IO}	$\geq 10^{11}$	Ω
Output safety power		P_{SO}	700	mW
Input safety current		I_{SI}	400	mA
Safety temperature		T_S	150	$^{\circ}\text{C}$
Clearance distance (DIP-8, widebody)			≥ 10	mm
Creepage distance (DIP-8, widebody)			≥ 10	mm
Insulation thickness		DTI	≥ 0.4	mm
Input to output test voltage, method B	$V_{IORM} \times 1.875 = V_{PR}$, 100 % production test with $t_M = 1\text{ s}$, partial discharge $< 5\text{ pC}$	V_{PR}	2651	V_{peak}
Input to output test voltage, method A	$V_{IORM} \times 1.6 = V_{PR}$, 100 % production test with $t_M = 10\text{ s}$, partial discharge $< 5\text{ pC}$	V_{PR}	2262	V_{peak}
Environment (pollution degree in accordance to DIN VDE 0109)			2	

Note

- As per DIN EN 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for “safe electrical insulation” only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits.



TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

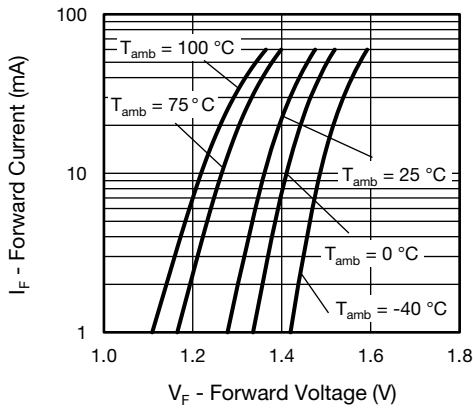


Fig. 4 - Output Current vs. Forward Voltage

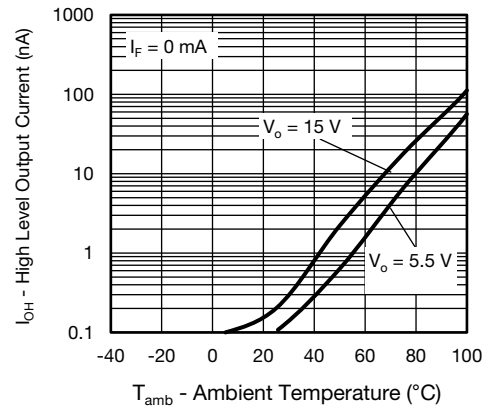


Fig. 7 - Logic High Level Output Current vs. Temperature

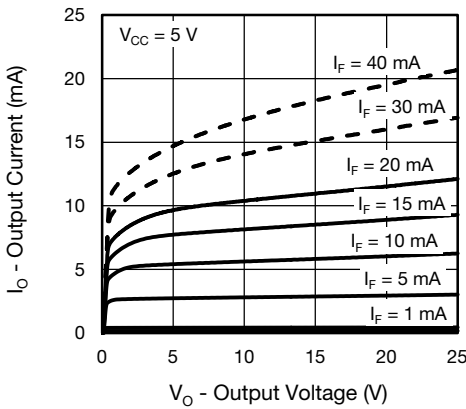


Fig. 5 - Output Current vs. Output Voltage

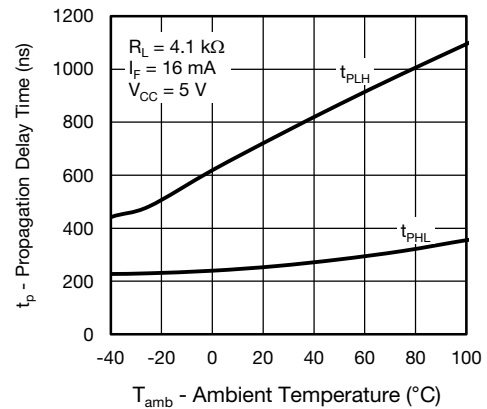


Fig. 8 - Propagation Delay vs. Ambient Temperature - VOW135

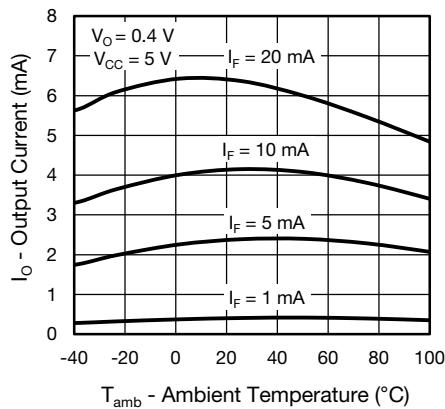


Fig. 6 - Output Current vs. Temperature

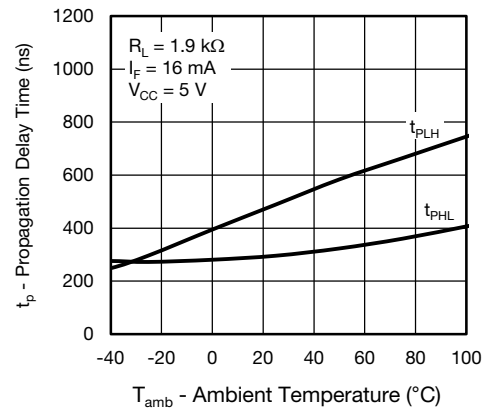


Fig. 9 - Propagation Delay vs. Ambient Temperature - VOW136

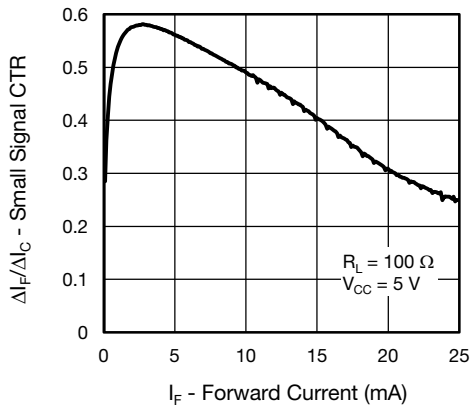


Fig. 10 - Small Signal Current Transfer Ratio vs. Forward Current

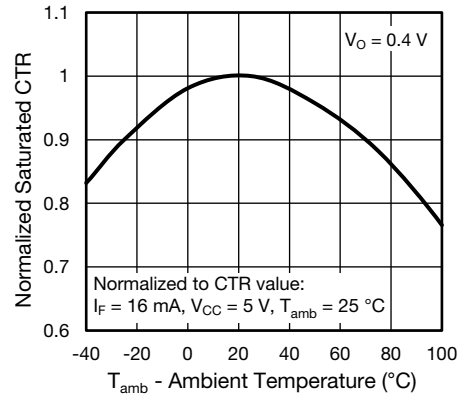


Fig. 13 - Normalized Saturated CTR vs. Ambient Temperature

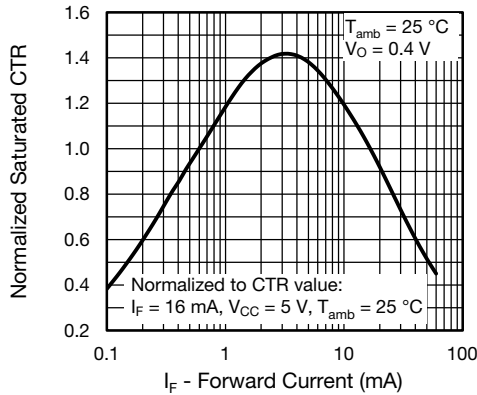


Fig. 11 - Normalized Saturated CTR vs. Forward Current

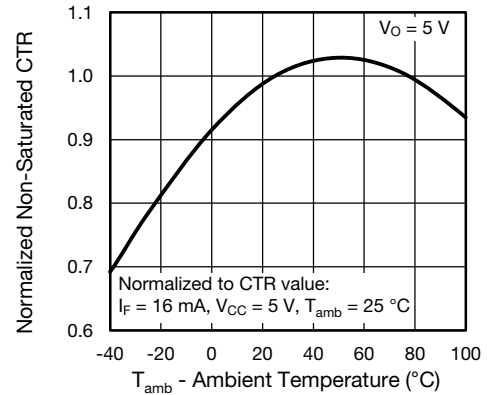


Fig. 14 - Normalized Non-Saturated CTR vs. Ambient Temperature

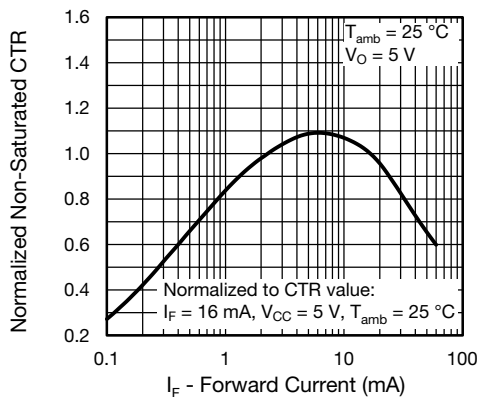
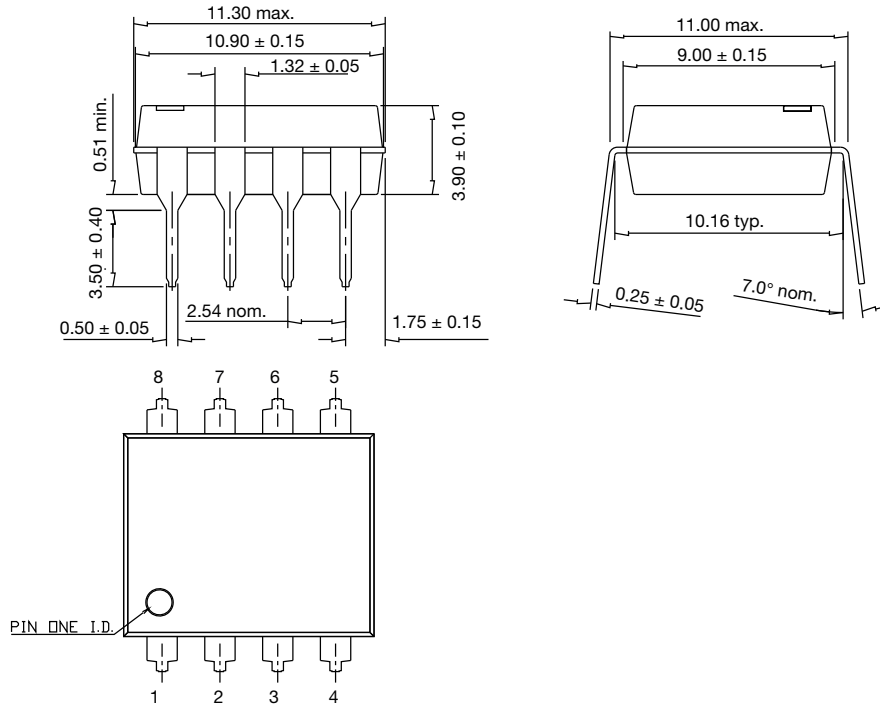


Fig. 12 - Normalized Non-Saturated CTR vs. Forward Current

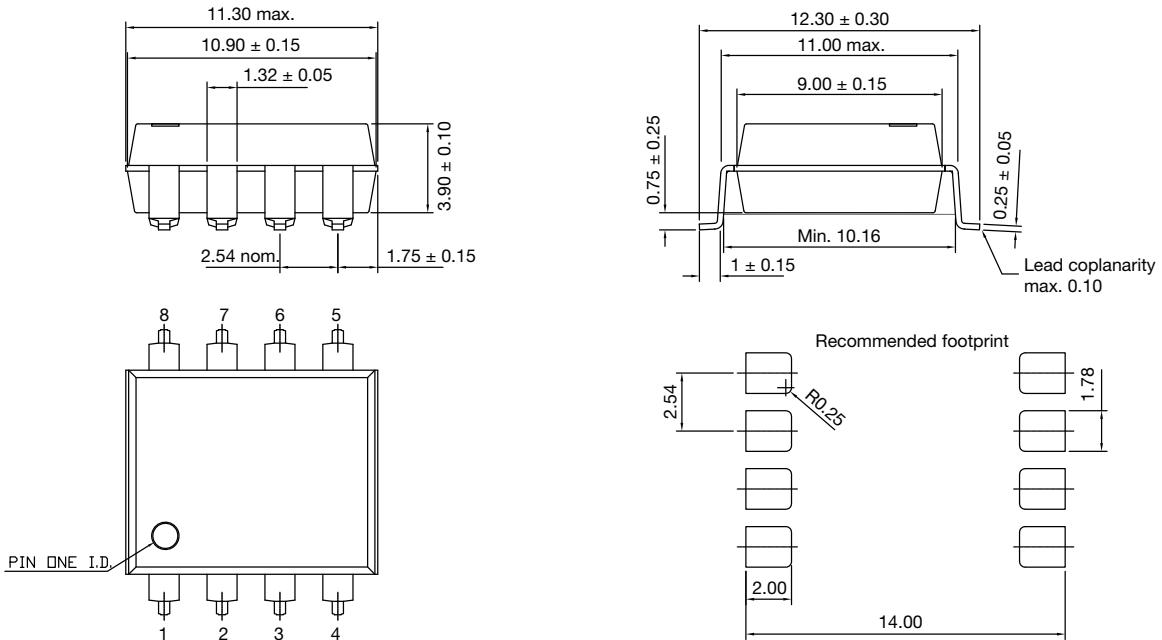


PACKAGE DIMENSIONS in millimeters

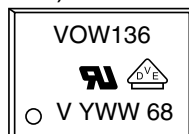
DIP-8, widebody



SMD-8, widebody (option 7)



PACKAGE MARKING (example of VOW136-X017T)



Note

- Tape and reel suffix (T) is not part of the package marking.

PACKING INFORMATION (tape and reel)

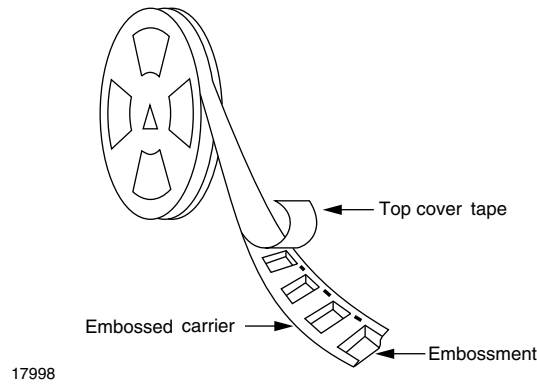


Fig. 15 - Tape and Reel Shipping Medium

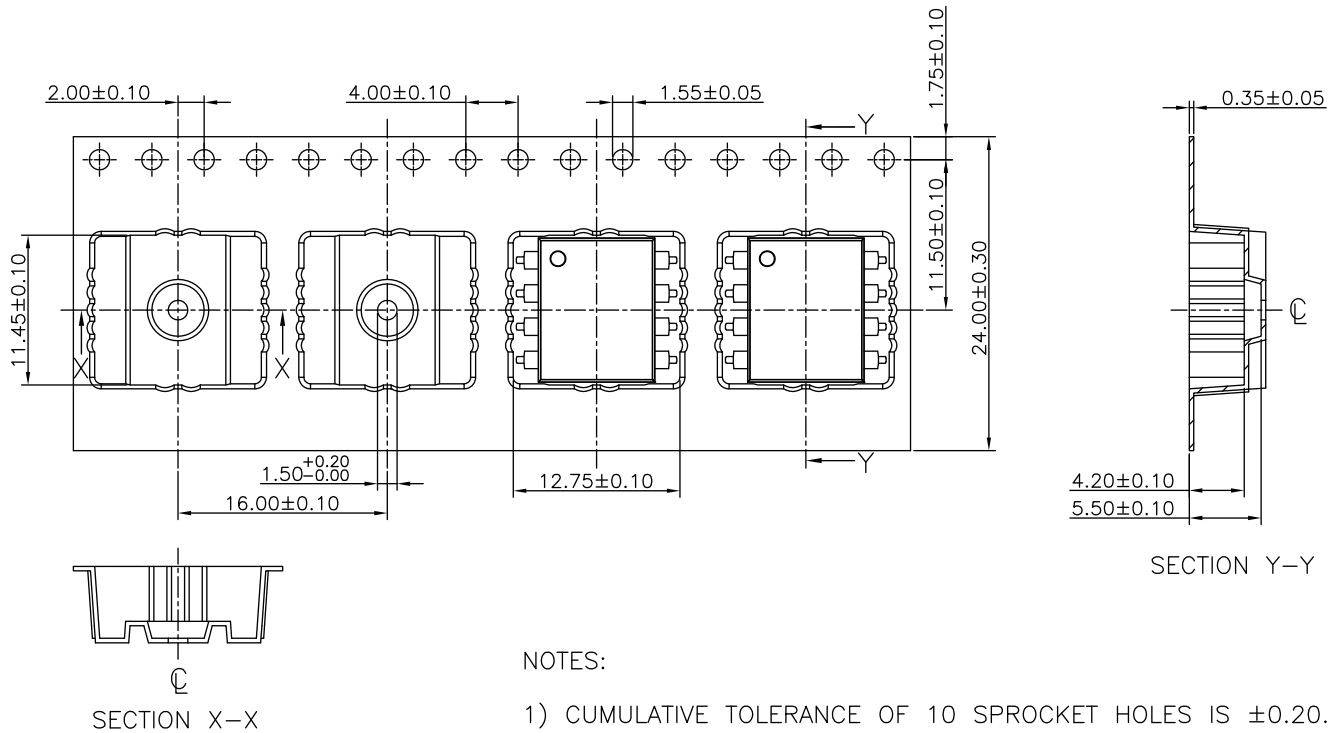
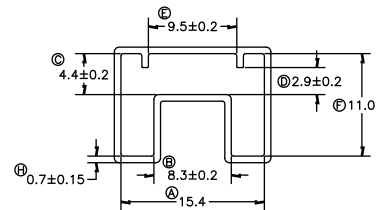
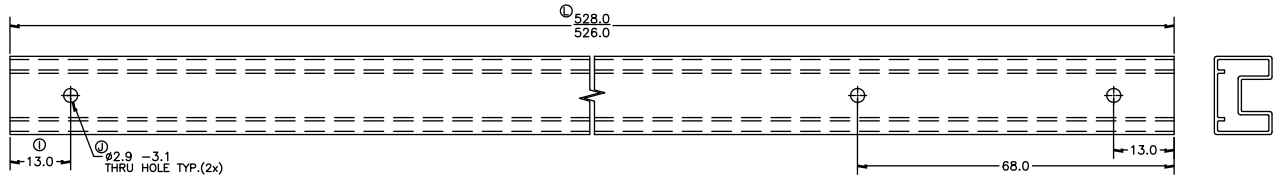


Fig. 16 - Tape and Reel Packing Option 7 (750 parts per reel)



PACKING INFORMATION (tubes)

DEVICE PER TUBE			
TYPE	UNITS/TUBE	TUBE/BOX	UNITS/BOX
DIP-8, widebody	40	30	1200



TUBE COLOUR:	CLEAR
PRINT COLOUR:	-

1. ALL DIMENSIONS ARE IN MILLIMETERS, U.O.S.

1. ALL TUBE TOLERANCES TO BE ± 0.25 UNLESS OTHERWISE SPECIFIED.
2. ALL RADII AND ANGLES REFERENCE ONLY, UNLESS OTHERWISE SPECIFIED.

SOLDER PROFILES

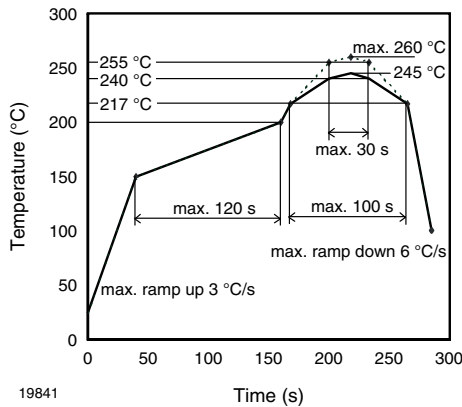


Fig. 17 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020 for SMD Devices

HANDLING AND STORAGE CONDITIONS

ESD level: HBM class 2

Floor life: unlimited

Conditions: $T_{amb} < 30\text{ °C}$, RH < 85 %

Moisture sensitivity level 1, according to J-STD-020



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